



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q78154

Kenichi OHKAWA, et al.

Appln. No.: 10/694,724

Group Art Unit: 1714

Confirmation No.: 4042

Examiner: Sandra K. Poulos

Filed: October 29, 2003

For: THERMOPLASTIC RESIN COMPOSITION AND ITS INJECTION MOLDED ARTICLE

NOTICE OF APPEAL

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant hereby appeals to the Board of Patent Appeals and Interferences from the final Office Action dated August 28, 2006.

A check for the statutory fee of \$500.00 is attached. The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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WASHINGTON OFFICE

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CUSTOMER NUMBER

Date: February 28, 2007

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